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Journal Name:	**British Journal of Applied Science & Technology**
Manuscript Number:	**2014_BJAST_15214**
Title of the Manuscript:	**MATERIAL SELECTION FOR HEAT SINKS IN HPC MICROCHIP-BASED CIRCUITRIES**
Type of the Article	**Original Research Article**

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PART 1: Review Comments

	Reviewer's comment	**Author's comment** *(if agreed with reviewer, correct the manuscript and highlight that part in the manuscript. It is mandatory that authors should write his/her feedback here)*
Compulsory REVISION comments	1. Please add more recent references in the manuscript. 2. Please check and revise references according to the principal of this journal. 3. Please add references of HPC microchips in the background.	
Minor REVISION comments	1. The Equation number used in this manuscript should meet the specifications of this journal. 2. The quality of pictures 6 - 8 need to be modified for clearness.	
Optional/General comments		

Reviewer Details:

Name:	**Yen-Tso Chang**
Department, University & Country	**Graduate institute of Mechanical and Electrical Engineering, National Taipei University of Technology, Taiwan**